







## **N0042Y Process Geometry**

#### **Features**

Typical Input Capacitance: 6pF

High Breakdown Voltage: -400V Typical
Small Die: 746um X 746um X 203um

Bond Pads: 95um DiameterSubstrate Connected to Gate

• Au Back-Side Finish

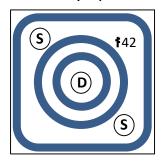
## **Applications**

- · General Purpose Amplifier
- · High Breakdown Voltage
- · Custom Part Options

### Description

The InterFET N0042Y Geometry is targeted for high voltage applications. The low input capacitance makes it ideal for higher frequency applications.

#### **Geometry Top View**



### **Standard Parts**

IFN6449, IFN6450

### **Product Summary**

	Parameters	Min	Тур	Max	Unit
BV <sub>GSS</sub>	Gate to Source Breakdown Voltage	-300	-400		V
I <sub>DSS</sub>	Drain to Source Saturation Current	2		10	mA
V <sub>GS(off)</sub>	Gate to Source Cutoff Voltage	-2		-12	V
$G_{FS}$	Forward Transconductance		0.8		mS

#### Maximum Ratings (@ T<sub>A</sub> = 25°C, Unless otherwise specified)

	Parameters	Min	Тур	Max	Unit
$V_{RGS}$	Reverse Gate to Source or Drain Voltage	-300	-400		V
$I_{FG}$	Continuous Forward Gate Current			10	mA
TJ	Operating Junction Temperature	-55		150	°C
Tstg	Storage Temperature	-65		175	°C



**Disclaimer:** It is the Buyers responsibility for designing, validating and testing the end application under all field use cases and extreme use conditions. Guaranteeing the application meets required standards, regulatory compliance, and all safety and security requirements is the responsibility of the Buyer. These resources are subject to change without notice.









## **Electrical Characteristics**

## Static Characteristics (@ TA = 25°C, Unless otherwise specified)

	Parameters	Conditions	Min	Тур	Max	Unit
BV <sub>GSS</sub>	Gate to Source Breakdown Voltage	$I_G = 1\mu A$ , $V_{DS} = 0V$	-300	-400		V
I <sub>GSS</sub>	Gate to Source Reverse Current	V <sub>GS</sub> = -150V, V <sub>DS</sub> = 0V		-1	-10	nA
$V_{GS(OFF)}$	Gate to Source Cutoff Voltage	$V_{DS} = 30V, I_{D} = 1nA$	-2		-12	V
I <sub>DSS</sub>	Drain to Source Saturation Current	$V_{DS} = 30V, V_{GS} = 0V$	2		10	mA

**Dynamic Characteristics** (@ TA = 25°C, Unless otherwise specified)

	Parameters	Conditions	Min	Тур	Max	Unit
G <sub>FS</sub>	Forward Transconductance	$V_{DS} = 30V, V_{GS} = 0V,$ f = 1kHz		0.8		mS
Ciss	Input Capacitance	$V_{DS} = 30V, V_{GS} = 0V,$ f = 1MHz		6	10	pF
C <sub>rss</sub>	Reverse Transfer Capacitance	$V_{DS} = 30V$ , $V_{GS} = 0V$ , $f = 1MHz$		2	5	pF
en	Noise Voltage	$V_{DS} = 30V, I_{D} = 2mA,$ f = 1kHz		7.5		nV/√Hz

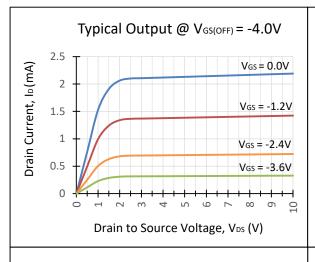


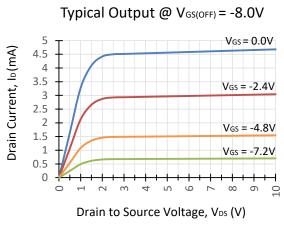


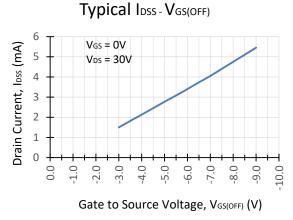


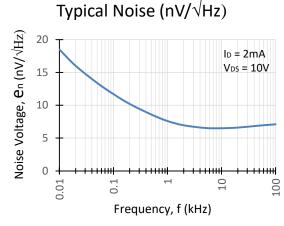


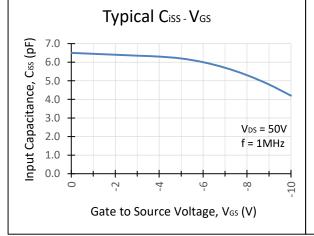
# **Typical N0042Y Characteristics**

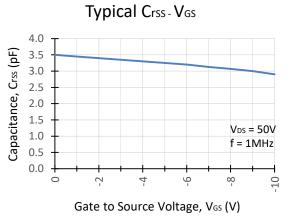














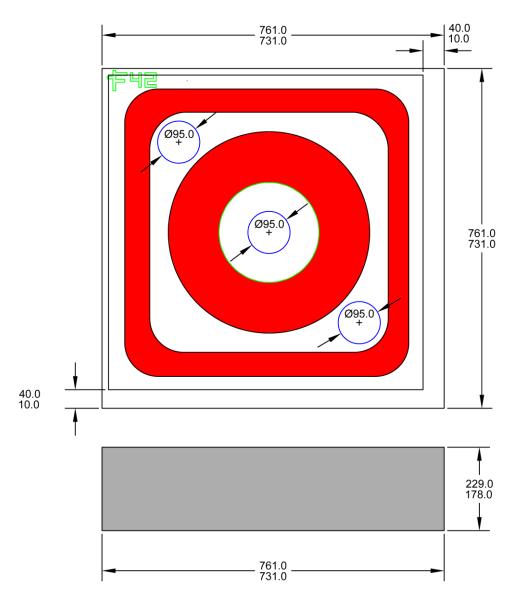






# **N0042Y Die Geometry Mechanical**

## **Raw Die Dimensions**



1. All linear dimensions are in micrometers.